RF/Microwave Capacitors RF/Microwave Multilayer Capacitors (MLC) 550-560 Series UBC™ Ultra-Broadband Capacitor







GENERAL DESCRIPTION

KYOCERA AVX new Ultra-Broadband Capacitor is manufactured with highest quality materials to provide reliable and repeatable Ultra-Broadband performance from 7KHz through 110GHz. It exhibits ultra-low insertion loss, flat frequency response and excellent return loss, and is ideal for D.C. Blocking, Coupling, Bypassing and Feedback applications requiring Ultra-Broadband performance.

TYPICAL CIRCUIT APPLICATIONS

- · Optoelectronics/High Speed Data
- Transimpedance amplifiers
- Receive and Transmit Optical Sub-Assembly (ROSA/TOSA)
- Synchronous Optical Network (SONET)
- Broadband test equipment
- Broadband Microwave/Millimeter Wave

HOW TO ORDER

550 Ζ Case Size Series W = 01005 550 Z = 0201560 L = 0402

Capacitance Code EIA Capacitance Code in pF.

First two digits = significant figures or "R" for decimal place. Third digit = number of zeros or after "R" significant figures

104

ADVANTAGES

- · Ultra-Broadband performance
- Ultra-Low Insertion Loss
- Flat Frequency Response
- Excellent Return Loss
- Unit-to-Unit Performance Repeatability
- Rugged Ceramic Construction
- Operating Temperature: -55°C to +125°C Note: See voltage below on the table at certain temp.

Termination Style Code

T = Tin Plated over Nickel Barrier (Standard) CA = Gold Plated over Nickel Barrier



Tape & Reel

Packaging T = 1000 pc qtyT\500 = 500 pc qty $T\4k = 4000 pc qty$ Z = 15K pc for 0201.20kpc for 01005

Т

ELECTRICAL SPECIFICATIONS

Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
550W103M	01005	160kHz	110GHz*	70GHz	10	35	25	16	Tin	
560W103M	01005	160kHz	55GHz	40GHz	10	35	25	16	Tin	
550W104M	01005	16kHz	110GHz*	70GHz	100	6.3	4	-	Tin	
560W104M	01005	16kHz	70GHz*	40GHz	100	6.3	4	-	Tin	T, Z
560Z104M	0201	16kHz	70GHz*	40GHz	100	25	16	6.3	Tin	Z
550Z104M	0201	16kHz	110GHz*	70GHz	100	25	16	6.3	Tin	
560Z224M	0201	7.2kHz	70GHz*	40GHz	220	16	10	4	Tin	
550Z224M	0201	7.2kHz	90GHz	70GHz	220	16	10	4	Tin	
550Z103P	0201	160kHz	100GHz	70GHz	10	10	10	6.3	Tin/Gold	T T\500 T\4K
560L102M	0402	1.6MHz	70GHz*	40GHz	1	100	100	100	Tin/Gold	
560L103M	0402	160kHz	70GHz*	40GHz	10	50	50	50	Tin/Gold	Т
560L223M	0402	72kHz	70GHz*	40GHz	25	25	25	25	Tin/Gold	T\4K
560L473M	0402	34kHz	70GHz*	40GHz	47	25	25	25	Tin/Gold	
560L104Y	0402	16kHz	70GHz*	40GHz	100	16	16	16	Tin	T T\500
550L104K	0402	16kHz	70GHz*	70GHz	100	16	16	16	Tin/Gold	T\4K

K

Capacitance

Tolerance

Code

K = ±10%

 $M = \pm 20\%$

P = +100%, -0% V = +20%, -10% Y = +25%, -20%

^{*}Highest Tested Frequency

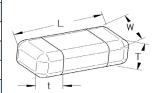
RF/Microwave Multilayer Capacitors (MLC)

550-560 Series UBC™ Ultra-Broadband Capacitor



GENERAL DIMENSIONS

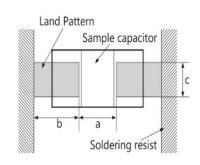
		550W104	560W104	560Z104	560Z224	560L104
L	mm	0.40 ± 0.02	0.40 ± 0.02	0.60 ± 0.03	0.60 ± 0.03	1.0 ± 0.1
(Length)	(in)	(0.016 ± 0.0008)	(0.016 ± 0.0008)	(0.024 ± 0.001)	(0.024 ± 0.001)	(0.040 ± 0.004)
W	mm	0.20 ± 0.02	0.20 ± 0.02	0.30 ± 0.03	0.30 ± 0.03	0.5 ± 0.1
(Width)	(in)	(0.008 ± 0.0008)	(0.008 ± 0.0008)	(0.012 ± 0.001)	(0.012 ± 0.001)	(0.020 ± 0.004)
Т	mm	0.22 Max	0.22 Max	0.22 Max	0.33 Max	0.6 Max
(Thickness)	(in)	0.009 Max	0.009 Max	0.009 Max	0.013 Max	0.024 Max
t	mm	0.135 ± 0.035	0.135 ± 0.035	0.15 ± 0.05	0.15 ± 0.05	0.36 ± 0.08
(Terminal)	(in)	(0.005 ± 0.0014)	(0.005 ± 0.0014)	(0.006 ± 0.002)	(0.006 ± 0.002)	(0.014 ± 0.003)



		550W103	560W103	550Z103	550Z104	550Z224	550L104
L	mm	0.40 ± 0.02	0.40 ± 0.02	0.58 ± 0.03	0.60 ± 0.03	0.60 ± 0.03	1.0 ± 0.1
(Length)	(in)	(0.016 ± 0.0008)	(0.016 ± 0.0008)	(0.023 ± 0.001)	(0.024 ± 0.001)	(0.024 ± 0.001)	(0.040 ± 0.004)
W	mm	0.20 ± 0.02	0.20 ± 0.02	0.32 ± 0.03	0.30 ± 0.03	0.30 ± 0.03	0.5 ± 0.1
(Width)	(in)	(0.008 ± 0.0008)	(0.008 ± 0.0008)	(0.0125 ± 0.0010)	(0.012 ± 0.001)	(0.012 ± 0.001)	(0.020 ± 0.004)
Т	mm	0.2 Max	0.2 Max	0.35 Max	0.22 Max	0.33 Max	0.6 Max
(Thickness)	(in)	0.008 Max	0.008 Max	0.013 Max	0.009 Max	0.013 Max	0.024 Max
t (Torminal)	mm	0.135 ± 0.035	0.135 ± 0.035	0.20 ± 0.04	0.23 ± 0.05	0.23 ± 0.05	0.42 ± 0.08
t (Terminal)	(in)	(0.005 ± 0.0014)	(0.005 ± 0.0014)	(0.008 ± 0.0015)	(0.009 ± 0.002)	(0.009 ± 0.002)	(0.0165 ± 0.0030)

REFLOW SOLDERING

560		01005	0201	0402
а	mm	0.10 - 0.15	0.20 - 0.25	0.40 - 0.60
d	(in)	(0.004 - 0.006)	(0.008 - 0.010)	(0.016 - 0.024)
b	mm	0.13 - 0.19	0.25- 0.35	0.40 - 0.50
D	(in)	(0.005 - 0.007)	(0.010 - 0.014)	(0.016 - 0.020)
С	mm	0.20 - 0.23	0.30 - 0.40	0.50 - 0.75
C	(in)	(0.008 - 0.009)	(0.012 - 0.016)	(0.020 - 0.030)
550		01005	0201	0402
	mm	01005 0.10 - 0.15	0201 0.10 - 0.15	0402 0.15 - 0.20
550	mm (in)			
а		0.10 - 0.15	0.10 - 0.15	0.15 - 0.20
	(in)	0.10 - 0.15 (0.004 - 0.006)	0.10 - 0.15 (0.004 - 0.006)	0.15 - 0.20 (0.006 - 0.008)
а	(in)	0.10 - 0.15 (0.004 - 0.006) 0.13 - 0.19	0.10 - 0.15 (0.004 - 0.006) 0.30 - 0.40	0.15 - 0.20 (0.006 - 0.008) 0.50 - 0.62



Parts are sensitive to orientation. Maintain packaging orientation for typical performance.

RF/Microwave Multilayer Capacitors (MLC)

550-560 Series UBC™ Ultra-Broadband Capacitor

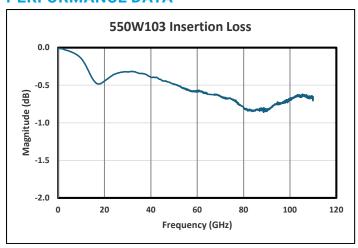


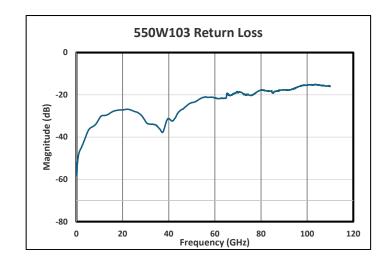
Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
550W103M	01005	160kHz	110GHz*	70GHz	10	35	25	16	Tin	T Z



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PERFORMANCE DATA





550W Data Sheet Test Condition Description

All testing performed on 5-mil-thick Rogers RO3003 board using recommended footprint (nominal 50-ohm characteristic impedance) @ Modelithics.

560W103M

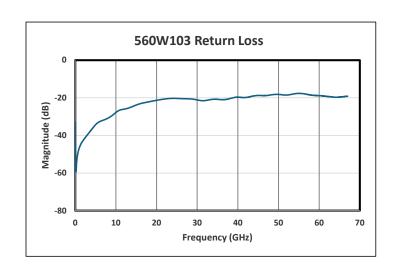
Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
560W103M	01005	160kHz	55GHz	40GHz	10	35	25	16	Tin	T Z



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560W Data Sheet Test Condition Description

All testing performed on 10-mil-thick Rogers RO3006 microstrip board, with the device under test subtending a 4 mil gap in a 14.2-mil-wide center trace (nominal 50-ohm characteristic impedance).

^{*}Highest Tested Frequency

RF/Microwave Multilayer Capacitors (MLC)

550-560 Series UBC™ Ultra-Broadband Capacitor

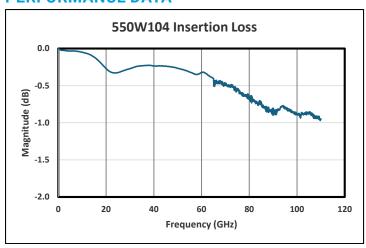


Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
550W104M	01005	16kHz	110GHz*	70GHz	100	6.3	4	-	Tin	T Z



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550W Data Sheet Test Condition Description

All testing performed on 5-mil-thick Rogers RO3003 board using recommended footprint (nominal 50-ohm characteristic impedance) @ Modelithics.

560W104M

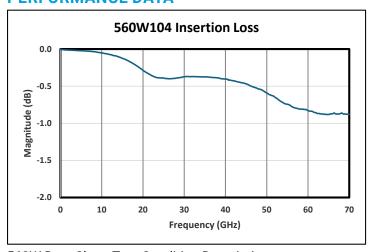
Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
560W104M	01005	16kHz	70GHz*	40GHz	100	6.3	4	-	Tin	T Z

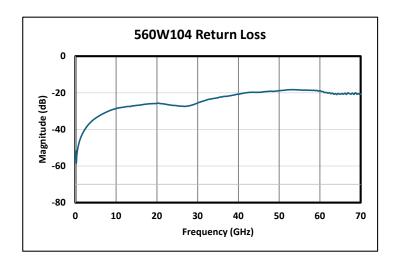


*Highest Tested Frequency

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PERFORMANCE DATA





560W Data Sheet Test Condition Description

All testing performed on 10-mil-thick Rogers RO3006 microstrip board, with the device under test subtending a 4 mil gap in a 14.2-mil-wide center trace (nominal 50-ohm characteristic impedance).

^{*}Highest Tested Frequency

RF/Microwave Multilayer Capacitors (MLC)

550-560 Series UBC™ Ultra-Broadband Capacitor



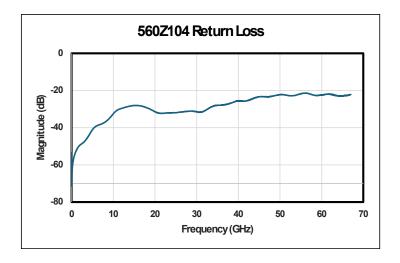
Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
560Z104M	0201	16kHz	70GHz*	40GHz	100	25	16	6.3	Tin	T Z



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560Z Data Sheet Test Condition Description

All testing performed on 5-mil-thick Rogers RO3003 board using recommended footprint (nominal 50-ohm characteristic impedance) @ Modelithics.

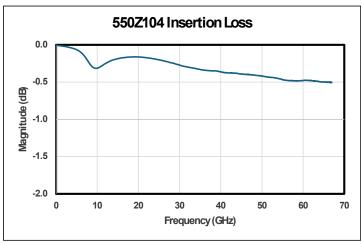
550Z104M

Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
550Z104M	0201	16kHz	110GHz*	70GHz	100	25	16	6.3	Tin	T Z



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550Z Data Sheet Test Condition Description

^{*}Highest Tested Frequency

^{*}Highest Tested Frequency

RF/Microwave Multilayer Capacitors (MLC)

550-560 Series UBC™ Ultra-Broadband Capacitor



560Z224M

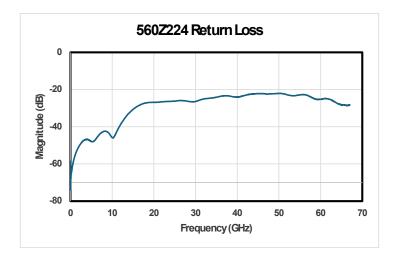
Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
560Z224M	0201	7.2kHz	70GHz*	40GHz	220	16	10	4	Tin	T Z



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560Z Data Sheet Test Condition Description

All testing performed on 5-mil-thick Rogers RO3003 board using recommended footprint (nominal 50-ohm characteristic impedance) @ Modelithics.

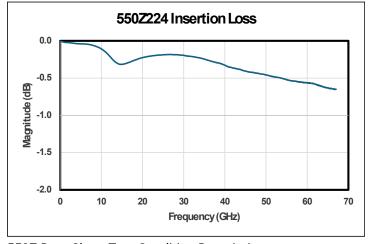
550Z224M

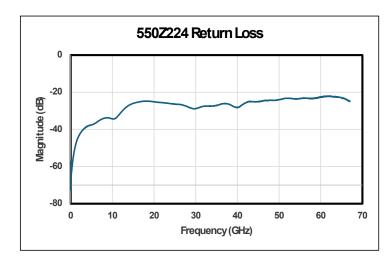
Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
550Z224M	0201	7.2kHz	90GHz	70GHz	220	16	10	4	Tin	T Z



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550Z Data Sheet Test Condition Description

^{*}Highest Tested Frequency

RF/Microwave Multilayer Capacitors (MLC)

550-560 Series UBC™ Ultra-Broadband Capacitor



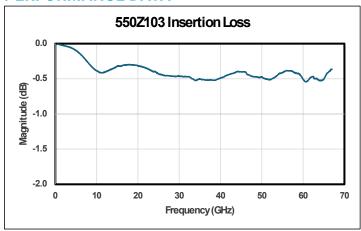
550Z103P

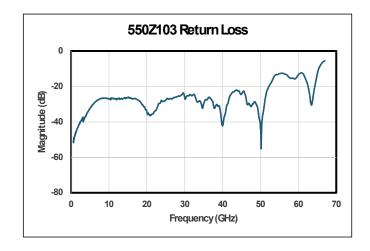
Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging	
550Z103P	0201	160kHz	100GHz	70GHz	10	10	10	6.3	Tin/Gold	T T\500 T\4K	



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550Z Data Sheet Test Condition Description

All testing performed on 5-mil-thick Rogers RO3003 board using recommended footprint (nominal 50-ohm characteristic impedance) @ Modelithics.

560L102M

Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
560L102M	0402	1.6MHz	70GHz*	40GHz	1	100	100	100	Tin/Gold	T T∖4K

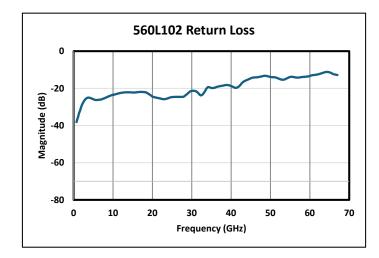


*Highest Tested Frequency

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550Z Data Sheet Test Condition Description

RF/Microwave Multilayer Capacitors (MLC)

550-560 Series UBC™ Ultra-Broadband Capacitor



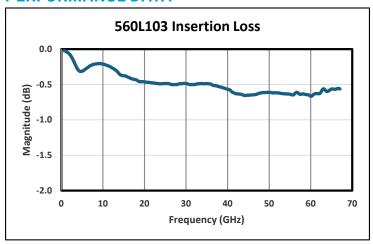
560L103M

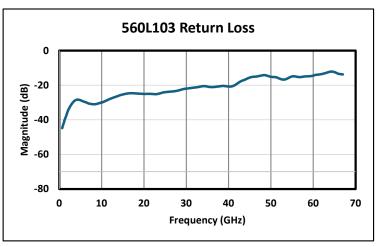
Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
560L103M	0402	160kHz	70GHz*	40GHz	10	50	50	50	Tin/Gold	T T\4K



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550Z Data Sheet Test Condition Description

All testing performed on 5-mil-thick Rogers RO3003 board using recommended footprint (nominal 50-ohm characteristic impedance) @ Modelithics.

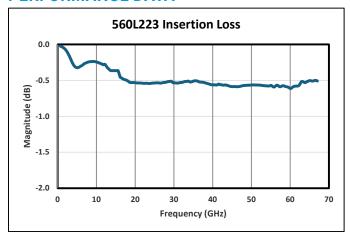
560L223M

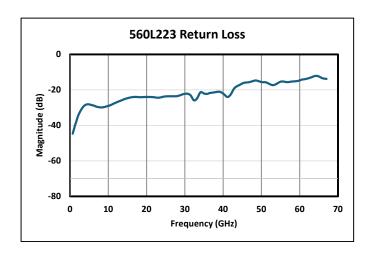
Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
560L223M	0402	72kHz	70GHz*	40GHz	25	25	25	25	Tin/Gold	T T∖4K



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550Z Data Sheet Test Condition Description

^{*}Highest Tested Frequency

^{*}Highest Tested Frequency

RF/Microwave Multilayer Capacitors (MLC)

550-560 Series UBC™ Ultra-Broadband Capacitor



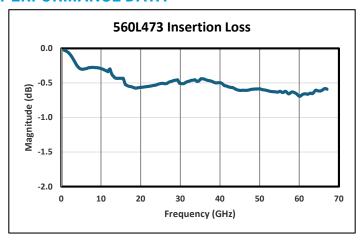
560L473M

Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
560L473M	0402	34kHz	70GHz*	40GHz	25	25	25	25	Tin/Gold	T T∖4K



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PERFORMANCE DATA





550Z Data Sheet Test Condition Description

All testing performed on 5-mil-thick Rogers RO3003 board using recommended footprint (nominal 50-ohm characteristic impedance) @ Modelithics.

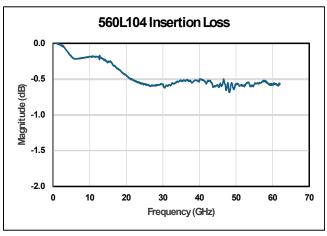
560L104Y

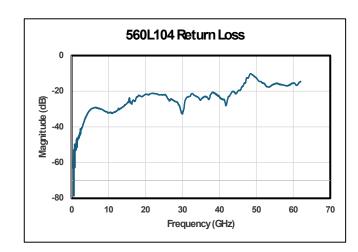
Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging
560L104Y	0402	16kHz	70GHz*	40GHz	100	16	16	16	Tin	T T\500 T\4K



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PERFORMANCE DATA





560L Data Sheet Test Condition Description

All testing performed on 10 mil-thick rogers RO4350B microstrip board, with the device under test subtending a 24 mil gap in a 22 mil-wide center trace (nominal 50 ohms characteristic impedance).

^{*}Highest Tested Frequency

^{*}Highest Tested Frequency

RF/Microwave Multilayer Capacitors (MLC)

550-560 Series UBC™ Ultra-Broadband Capacitor

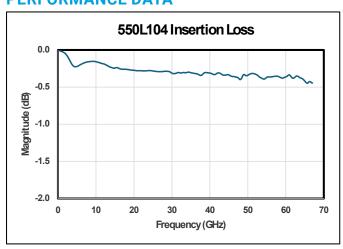


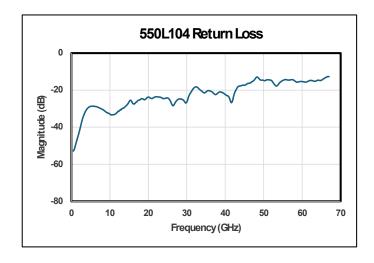
550L104K

Series	Size (EIA)	Min Freq.	Max Freq. for IL <1dB (Typical)	Max Freq. for IL <0.5dB (Typical)	Cap (nF)	WVDC (85C)	WVDC (105C)	WVDC (125C)	Finish	Packaging	
550L104K	0402	16kHz	70GHz*	70GHz	100	16	16	16	Tin/Gold	T T\500 T\4K	
*Highest Tested	Highest Tested Frequency Click here to return to main table										



PERFORMANCE DATA





550L Data Sheet Condition Description

All testing performed on 10 mil-thick rogers RO4350B microstrip board, with the device under test subtending a 24 mil gap in a 22 mil-wide center trace (nominal 50 ohms characteristic impedance)

SIMULATION MODELS



KYOCERA AVX and Modelithics have partnered to offer FREE 90-Day trials of highly accurate, scalable advanced simulation models for various KYOCERA AVX parts including THIS part as well as Attenuators, Capacitors, Couplers, Inductors, Diplexers, Resistors.

For More Information, Please Visit: https://www.modelithics.com/mvp/avx Use Promo Code: AVXWP

^{*}Highest Tested Frequency

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

KYOCERA AVX:

550L104KCA 550L104KTT 550Z103PTT 550Z103PCAT 550L104KCAT 550L104KTT5 550Z103PCAT\500

550L104KCAT\500 550L104KTT\4K 550L104KTT\500 550Z103PTT\500 550W103MTT 550Z104MTT 550Z224MTT

560W104MTT 560Z104MTT 560Z224MTT 550W104MTT 560W103MTT 560L102MTT 560L223MTT

560L473MTT 560L103MTT